



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

April 29, 2009

Applicants: Masashi KUMAGAI et al

Title: COPPER ELECTROLYTIC SOLUTION AND
ELECTROLYTIC COPPER FOIL PRODUCED THEREWITH

Serial No.: 10/531 645

Group: 1795

Confirmation No.: 1483

Filed: April 15, 2005

Examiner: Mendez

International Application No.: PCT/JP2003/013044

International Filing Date: October 10, 2003

Atty. Docket No.: 4700.P0312US

Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

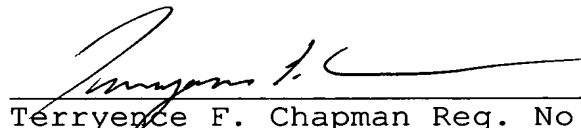
Herewith is an amendment in the above-identified application.

☐ Applicant claims small entity status. See 37 CFR 1.27.☐ The additional filing fee has been calculated as shown below:

For	No. Filed	No. Extra	(X) LG Entity	RATE	() SM Entity	Fee
Total Claims	(5 - 20 = 0)		x	\$ 52.00	x	\$ 26.00
Indep. Claims	(1 - 3 = 0)		x	\$220.00	x	\$110.00
[] Multiple Dep. Claim			+	\$390.00	+	\$195.00
* * * TOTAL FILING FEE * * *						\$ 0.00

☐ Pursuant to 37 CFR 1.136(a), please extend the shortened period for response by month(s). The extension fee is: \$.☐ A Check for \$ is enclosed to cover fees.☒ Please credit any overpayment, or charge any additional filing fee required under 37 CFR 1.16 or 1.17 by this communication, to Deposit Account No. 06-1382.

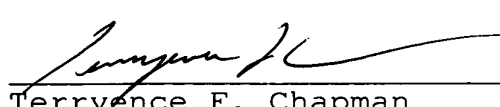
TFC/smd


Terryence F. Chapman Reg. No. 32 549

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 29, 2009.

130.10/08


Terryence F. Chapman